

HAT2188WP

Silicon N Channel Power MOS FET Power Switching

REJ03G0534-0500

Rev.5.00

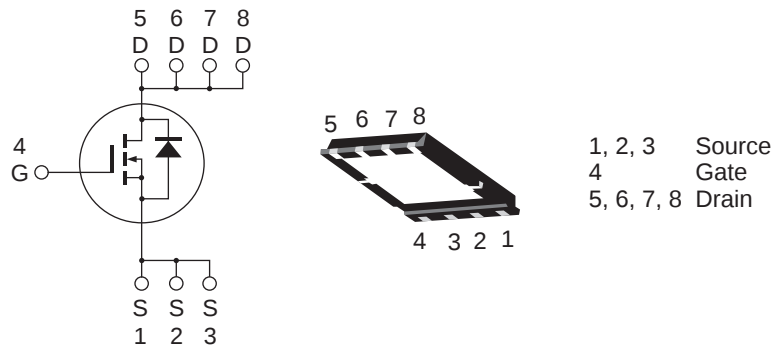
Mar.24.2005

Features

- Low on-resistance
- Low drive current
- High density mounting

Outline

RENESAS Package code: PWSN0008DA-A
(Package name: WPAK)



Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to Source voltage	V_{DSS}	200	V
Gate to Source voltage	V_{GSS}	± 30	V
Drain current	I_D	12	A
Drain peak current	$I_{D(pulse)}$ ^{Note1}	24	A
Body-Drain diode reverse Drain current	I_{DR}	12	A
Body-Drain diode reverse Drain peak current	$I_{DR(pulse)}$ ^{Note1}	24	A
Avalanche current	I_{AP} ^{Note3}	12	A
Avalanche energy	E_{AR} ^{Note3}	9.6	mJ
Channel dissipation	P_{ch} ^{Note2}	25	W
Channel to case thermal impedance	θ_{ch-c}	5	°C/W
Channel temperature	T_{ch}	150	°C
Storage temperature	T_{stg}	-55 to +150	°C

Notes: 1. $PW \leq 10 \mu s$, duty cycle $\leq 1\%$

2. Value at $T_c = 25^\circ C$

3. $STch = 25^\circ C$, $T_{ch} \leq 150^\circ C$

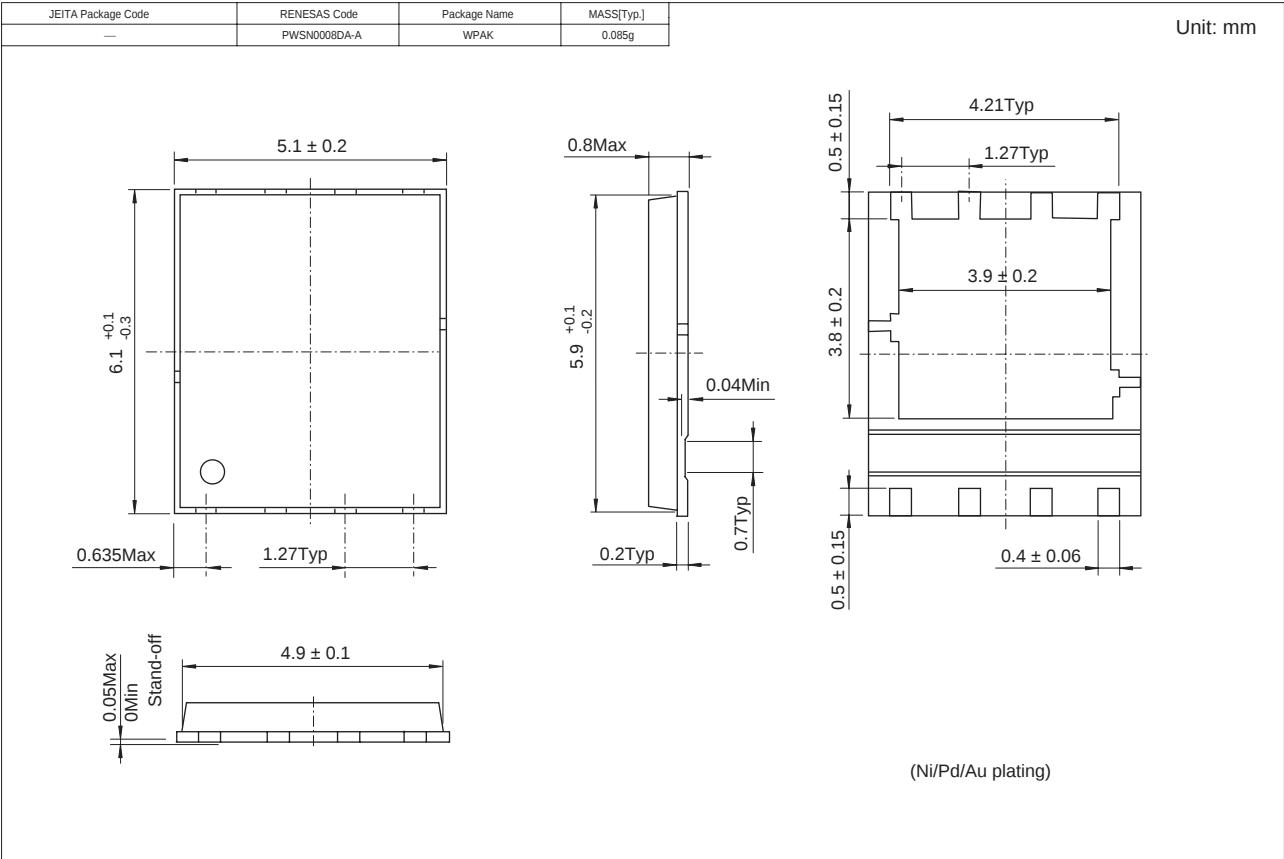
[Electrical Characteristics](#) 供应商

(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to Source breakdown voltage	$V_{(BR)DSS}$	200	—	—	V	$I_D = 10 \text{ mA}$, $V_{GS} = 0$
Zero Gate voltage Drain current	I_{DSS}	—	—	1	μA	$V_{DS} = 200 \text{ V}$, $V_{GS} = 0$
Gate to Source leak current	I_{GSS}	—	—	± 0.1	μA	$V_{GS} = \pm 30 \text{ V}$, $V_{DS} = 0$
Gate to Source cutoff voltage	$V_{GS(off)}$	3.0	—	4.5	V	$V_{DS} = 10 \text{ V}$, $I_D = 1 \text{ mA}$
Forward transfer admittance	$ y_{fs} $	5	9	—	S	$I_D = 6 \text{ A}$, $V_{DS} = 10 \text{ V}$ ^{Note4}
Static Drain to Source on state resistance	$R_{DS(on)}$	—	0.135	0.157	Ω	$I_D = 6 \text{ A}$, $V_{GS} = 10 \text{ V}$ ^{Note4}
Input capacitance	C_{iss}	—	710	—	pF	$V_{DS} = 25 \text{ V}$ $V_{GS} = 0$ $f = 1 \text{ MHz}$
Output capacitance	C_{oss}	—	140	—	pF	
Reverse transfer capacitance	C_{rss}	—	11	—	pF	
Turn-on delay time	$t_{d(on)}$	—	26	—	ns	$I_D = 6 \text{ A}$ $V_{GS} = 10 \text{ V}$ $R_L = 16.7 \Omega$ $R_g = 10 \Omega$
Rise time	t_r	—	27	—	ns	
Turn-off delay time	$t_{d(off)}$	—	54	—	ns	
Fall time	t_f	—	7	—	ns	
Total Gate charge	Q_g	—	15	—	nC	$V_{DD} = 160 \text{ V}$ $V_{GS} = 10 \text{ V}$ $I_D = 12 \text{ A}$
Gate to Source charge	Q_{gs}	—	4	—	nC	
Gate to Drain charge	Q_{gd}	—	6	—	nC	
Body-Drain diode forward voltage	V_{DF}	—	0.85	1.4	V	$I_F = 12 \text{ A}$, $V_{GS} = 0$ ^{Note4}
Body-Drain diode reverse recovery time	t_{rr}	—	110	—	ns	$I_F = 12 \text{ A}$, $V_{GS} = 0$ $diF/dt = 100 \text{ A}/\mu\text{s}$

Notes: 4. Pulse test

查看"HAT2188WP-EL-E"供应商



Ordering Information

Part Name	Quantity	Shipping Container
HAT2188WP-EL-E	2500 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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